

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4211528

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YANG LU	12/07/2016
JIAN SONG	12/07/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	CITY UNIVERSITY OF HONG KONG
<b>Street Address:</b>	83 TAT CHEE AVENUE
<b>City:</b>	KOWLOON
<b>State/Country:</b>	HONG KONG
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15399006
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(330)376-9646
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	330-376-1242
<b>Email:</b>	pto@rennerkenner.com
<b>Correspondent Name:</b>	RENNER KENNER GREIVE BOBAK TAYLOR & WEBE
<b>Address Line 1:</b>	FIRST NATIONAL TOWER, SUITE 400
<b>Address Line 2:</b>	106 SOUTH MAIN STREET
<b>Address Line 4:</b>	AKRON, OHIO 44308-1412
<b>ATTORNEY DOCKET NUMBER:</b>	MKC.P.213
<b>NAME OF SUBMITTER:</b>	MARK L. WEBER
<b>SIGNATURE:</b>	/marklweber/
<b>DATE SIGNED:</b>	01/05/2017
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 1</b>	
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**Assignment**

**In Consideration** of good and valuable consideration provided to the undersigned by the Assignee, City University of Hong Kong, 83 Tat Chee Avenue, Kowloon, Hong Kong, the receipt of which is hereby acknowledged, the undersigned by these presents hereby sold, assigned, transferred and set over unto the said Assignee the entire right, title and interest in and to the improvement in:

**A COMPOSITE MATERIAL COMPOSITION AND A METHOD OF FORMING A COMPOSITE MATERIAL COMPOSITION**

said invention being fully described and/or claimed in the application for Letters Patent of the United States of America in and for the United States and all foreign countries, the same to be held and enjoyed by said Assignee, his successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patents therefore may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

**And Said Assignee is Hereby Authorized** to make application for and to receive Letters Patent for said invention in any of said countries of its election.

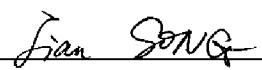
**And By This Covenant The Undersigned** will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said Assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefore in said Assignee, his successors, assigns or other legal representatives and upon the request and at the expense of said Assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of said Letters Patents to be granted therefore, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein without further compensation, but at the expense of said Assignee, his successors, assigns or other legal representatives.

**And The Commissioner of Patents is Hereby Authorized and Requested** to issue any and all Letters Patents of the United States for said invention, to said Assignee.

**Signed and sealed:**

  
\_\_\_\_\_  
LU, Yang

07/12/2016  
\_\_\_\_\_  
Date

  
\_\_\_\_\_  
SONG, Jian

07/12/2016  
\_\_\_\_\_  
Date